ALAGAPPA UNIVERSITY, KARAIKUDI NEW SYLLABUS UNDER CBCS PATTERN (w.e.f.2023-24) UG- Science-PROGRAMME STRUCTURE

B.Sc., Electronics

Sem.	Part	Course	Courses	Title of the Paper	T/P	Cr.	Hrs./	N	Max. Marks		
	ı aı ı	Code		Title of the Laper			Week	Int.	Ext.	Total	
	I	2311T	T/OL	தமிழ் இலக்கிய வரலாறு-I /Other Languages -I	Т	3	6	25	75	100	
	II	2312E	Е	General English - I	Т	3	6	25	75	100	
		23BEL1C1	CC-I	Electronic Devices and Network Analysis	Т	4	5	25	75	100	
I	III	23BEL1P1	CC-II	Electronic Devices and Network Analysis Lab	P	4	4	25	75	100	
1	111	-	Generic Elective	Maths/ Computer Science/BCA/ B.Sc., IT/ Physics / Chemistry	T	3	3	25	75	100	
		-	(Allied)	Allied Lab-Respective Allied Theory Course	P	2	2	25	75	100	
		23BEL1S1	SEC -I	Programming in C	Т	2	2	25	75	100	
	IV	23BEL1FC	Foundation Course	Fundamentals for Electronics	T	2	2	25	75	100	
				Total		23	30	200	600	800	
	I	2321T	T/OL	தமிழ் இலக்கிய வரலாறு-2 /Other Languages-II	Т	3	6	25	75	100	
	II	2322E	Е	General English - II	Т	3	6	25	75	100	
		23BEL2C1	CC-III	Electronic Circuits	Т	4	5	25	75	100	
		23BEL2P1	CC-IV	Electronic Circuits Lab	P	4	4	25	75	100	
II	III		Generic	Maths/ Computer Science/BCA/ B.Sc., IT/ Physics / Chemistry	Т	3	3	25	75	100	
			Elective (Allied)	Allied Lab-Respective Allied Theory Course	P	2	2	25	75	100	
	IV	23BEL2S1	SEC -II	Photonics And Optoelectronics	Т	2	2	25	75	100	
		23BEL2S2	SEC-III	Sensor and Virtual Instrumentation	Т	2	2	25	75	100	
			NMC	Naan Mudhalvan Course	Т						
				Total		23	30	200	600	800	
	I	2331T	T/OL	தமிழக வரலாறும் பண்பாடும் /Other Languages-III	Т	3	6	25	75	100	
	II	2332E	E	General English – III	T	3	6	25	75	100	
		23BEL3C1	CC-V	Digital Electronics	T	4	5	25	75	100	
III		23BEL3P1	CC-VI	Digital Electronics Lab	P	4	4	25	75	100	
111	III		Generic Elective	Maths/ Computer Science/BCA/ B.Sc., IT/ Physics / Chemistry	Т	3	3	25	75	100	
			(Allied)	Allied Lab-Respective Allied Theory Course	P	2	2	25	75	100	
		23BEL3S1	SEC-IV	Electronic Instrumentation	T	2	2	25	75	100	
		233AT/ 23BEL3S2	SEC-V	Adipadai Tamil /Digital Logic with VHDL Design	T	2	2	25	75	100	
				Total		23	30	200	600	800	
IV	I	2341T	T/OL	தமிழும் அறிவியலும் /Other	T	3	6	25	75	100	

				Languages -IV						
	II	2342E	Е	General English – IV	T	3	4	25	75	100
		23BEL4C1	CC-VII	Analog Integrated Circuits	T	4	5	25	75	100
		23BEL4P1	CC-VIII	Analog Integrated Circuits Lab	P	4	4	25	75	100
II	III		Generic Elective	Maths/ Computer Science/BCA/ B.Sc., IT/ Physics / Chemistry	T	3	3	25	75	100
			(Allied)	Allied Lab-Respective Allied Theory Course	P	2	2	25	75	100
		23BEL4S1	SEC-VI	Microprocessor Programming and Interfacing Techniques	T	2	2	25	75	100
	IV	234AT/ 23BEL4S2	SEC-VII	Adipadai Tamil /Medical Electronics	T	2	2	25	75	100
		23BES4	E.V.S	Environmental Studies	T	2	2	25	75	100
				Total		25	30	225	675	900
			1		_		_			
		23BEL5C1	CC-IX	Embedded System Design	T	4	5	25	75	100
		23BEL5C2	CC-X	Electronic Communication system	T	4	5	25	75	100
	III	23BEL5C3	CC-XI	Power Electronics	T	4	5	25	75	100
V		23BEL5P1		Embedded System Design,	P					
'			CC-XII	Communication and Power		4	5	25	75	100
				Electronics Lab						
	23BEL5E1	DSE-I	Internet of Things With Arduino	T	3	4	25	75	100	
		23BEL5E2	DSE-II	Computer Networking	T	3	4	25	75	100
	IV	23BVE5		Value Education	T	2	2	25	75	100
	1 V	23BEL5I		Internship/Industrial Visit/ Field Visit		2	-			
				Total		26	30	175	525	700
		23BEL6C1	CC-XIII	Advanced Communication Systems	T	4	6	25	75	100
		23BEL6PR	CC-XIV	Project		8	12	25	75	100
		23BEL6E1	DSE-III	Computer Hardware And System Assembling.	Т	3	5	25	75	100
VI		23BEL6E2	DSE-IV	Java Programming	T	3	5	25	75	100
				Extension Activity		1	-	-	-	
		23BEL6S1	PCS	Troubleshooting And Maintenance of Mobile Cell Phones, CCTV And LED/LCD TV		2	2	25	75	100
				Total		21	30	150	450	500
				Grand Total		141	-			4300

- > TOL-Tamil/Other Languages,
- ightharpoonup E English
- > CC-Core course
- ➤ Generic Elective (Allied)
- > AECC- Ability Enhancement Compulsory Course
- > SEC-Skill Enhancement Course
- > FC-Foundation Course
- > DSE Discipline Specific Elective

			Semester - I						
Course Co	de		Core Course	I	T/P	C	H/W		
23BEL1C1		Electronic D	Devices and Net	work Analysis	T	4	5		
				ll in circuit analysis					
	> To acquir	e knowledge on o	charge transport	in semiconductors	and to u	ınders	tand the		
Objectives		nstituted in semi							
		stand the constru	action and world	king function of va	rious s	emico	nductor		
	devices.								
		*		Resistance – Induc					
Unit - I				evenin's Theorem-					
				onance: Series res			-		
	resonance R	LC circuits – Res	onant frequency	y – Q factor – Band	width –	Selec	tivity.		
	Semiconductor : Classification of semiconductors – Conductivity of semiconductor –								
Unit - II	Energy distribution of electrons – Carrier concentration in intrinsic semiconductor –								
	Mass action Law – Drift and diffusion currents – Carrier Life time – Continuity								
	Equation.								
	Semiconductor diodes : PN junction diode in equilibrium with no applied voltage – PN junction diode under forward bias condition – PN junction diode under reverse								
Unit - III									
	bias condition –Diode current equation - Space Charge Capacitance - Zener Diode – Avalanche and Zener Break down mechanism.								
				ction Transistor con	structio	n -Tr	ansistor		
	1 -		-						
Unit – IV	biasing- Operation of NPN and PNP Transistor - Transistor current components - CE								
	configuration - CB Configuration - CC configuration - Comparison of different configurations - h parameter Model.								
	_			N. Cl. 1 IEEE			CAI		
				N – Channel JFET					
11	Channel JFET – Characteristic Parameters of the JFET – Expression for Saturation								
Unit - V	Drain Current –JFET as VVR- Enhancement MOSFET – Depletion MOSFET – Comparison of MOSFET with JFET- UJT construction and working – V- I								
	Characterist		with JrE1- O.	or construction an	u wor	Killig -	- v- 1		
Text Book:		C S.							
		lastuania Davisa	MoChary IIII	Education 2nd Editi	0.40				

Salivahanan, S. (2016). *Electronic Devices*. McGraw Hill Education, 2nd Edition.

Reference Books:

Jacob Millman, & Halkias, C. Electronic Devices and Circuits. Tata McGraw Hill

Salivahanan, S., Sureshkumar, N., & Vallavaraj, A. (2008). *Electronic Devices and Circuits*. Tata McGraw Hill Second Edition.

Sedha, R.S.(2013). A Text Book of Applied Electronics (Revised Edition). S.Chand and Co Ltd,

	\triangleright	* * *
Outcomes	A	The skill will be developed to choose proper semiconductor devices for specific applications.

		Semester - I						
Course Co	de	Core Practical I	T/P	C	H/W			
22BEL1P1		ELECTRONIC DEVICES AND NETWORK	P	4	4			
		ANALYSIS LAB						
	➤ To	know how to Handling Multimeter, CRO to check th	e comp	pone	nts and			
	mea	sure various parameters like continuity, resistance value,	, Volta	ge, (Current,			
Objectives	Freq	requency, Time, and how to use the instruments for troubleshooting.						
	➤ To a	To apply the knowledge gained from theory to analyze various dc and ac circuits						
	and apply various theorems to minimize and find the equivalent circuit							
	To study the characteristics of diodes, BJT, FET, and UJT							
1. Fan	niliarizati							
		in series, parallel and series – Parallel.						
/		& Inductors in series & Parallel.						
/		r – Checking of components.						
/		ources in series, parallel and series – Parallel						
/	_	d Current dividers						
/	_	of Amplitude, Frequency & Phase difference using CRO.						
		Kirchoff's Laws.						
		Norton's theorem.						

- 7. Verification of Notion's incorem.
- 5. Verification of Thevenin's Theorem.
- 6. Verification of Superposition Theorem.
- 7. Verification of the Maximum Power Transfer Theorem.
- 8. Study of the Frequency Response of a Series LCR Circuit and determination of its (a) Resonant Frequency(b) Impedance at Resonance (c) Quality Factor Q (d) Band Width.
- 9. Study of the Frequency Response of a Parallel LCR Circuit and determination of its (a) Resonant Frequency (b) Impedance at Resonance (c) Quality Factor Q (d) Band Width.
- 10.V-I Characteristics of PN Junction Diode
- 11. Reverse Bias Characteristics of Zener Diode
- 12.V-I Characteristics of CB Configuration of BJT
- 13. V-I Characteristics of CE Configuration of BJT
- 14.V-I Characteristics of JFET
- 15. JFET as Voltage variable Resistance
- 16. V-I Characteristics of MOSFET
- 17.V- I Characteristics of UJT

	> Students will be able to handle Multimeter, CRO, Power Supply, and
	Function generator to measure the parameters.
0.4	> Acquired knowledge of the device operation and to measure
Outcomes	variousparameters using multimeter, voltmeter, ammeter and CRO
	With the knowledge of parameters one can select the device for circuit design
	for various applications

	Semester - I										
Course Coo	le IV- SEC –I	T/P	C	H/W							
23BEL1S1	Programming in C	T	2	2							
Objectives	 Learn Fundamentals in C, Operators, data types and Exp. Learn the syntax of control and looping statements Learn numeric and string array declaration, initialization functions Learn the syntax of user defined functions Learn pointers, structures and file management. 	 Learn the syntax of control and looping statements Learn numeric and string array declaration, initialization and sting handling functions Learn the syntax of user defined functions 									
Unit - I	Overview of C: Basic structure of C program - executing a C program basic structure of C program - executing a C program basic structure of C program - executing a C program basic structure of C program - executing a C program basic structure of C program - executing a C program basic structure of C program - executing a C program - execu	erview of C: Basic structure of C program - executing a C program - Constants, riable and Data Types: Introduction, Character Set, C Tokens, Keywords and ntifiers, Constants, Variables, Data Types, Declaration of Variables, Assigning lues to Variables, Defining Symbolic Constants. Operators – Expressions – Type									
Unit - II	Statement - the IF-ELSE Statement - Nesting of IF-ELSE Statement - The Switch statement - The ? : Operator - The goto statement - The statement - The goto statement - The statement - The goto statement - The statement - The statement - The goto statement - The statement - The statement - The goto statement - The statement - The statement - The goto statement - The statement - The statement - The goto statement - The statement - The goto statement	Decision Making and Branching: Decision Making with IF Statement - Simple IF Statement - the IF-ELSE Statement - Nesting of IF-ELSE Statements- The ELSE IF Ladder, The Switch statement - The?: Operator - The goto statement- Decision Making and Looping: The while Statement - The do statement-The for statement -									
Unit - III	Arrays And Strings Arrays: One-dimensional Arrays - Declarated dimensional Arrays - Initialization of One-dimensional Arrays - Tarrays - Declaration of Two-dimensional Arrays - Initialization of Arrays - Character Arrays and Strings: Declaring and Initializing Streading Strings from Terminal - Writing Strings to Screen-Arithm Characters- String-handling Functions.	wo-din Two-d tring V	nensi imen ariab	sional oles -							
Unit - IV	Functions: User-defined Functions: Need for functions- Elements Functions- Definition of Functions- Return Values and their Types Function Declaration- Category of Functions- No Arguments and I	unctions: User-defined Functions: Need for functions- Elements of User-defined anctions- Definition of Functions- Return Values and their Types- Function Callsmotion Declaration- Category of Functions- No Arguments and no Return Values-guments but no Return values - Arguments with Return Values- No Arguments but									
Unit - V	Pointers, Structures and File Management: Pointers: Intro Pointer Variables- Initialization of Pointer variables - accessing a Pointer- Pointer Expressions- Pointer Increments and Scale Introduction- Defining a structure- declaring structure variablesmembers- structure initialization- array of structures File Hand opening a file- closing a file.	Variabl Factor. accessi	e thro St ing s	ough its ructure: tructure							

Text Book:

E. Balaguruswamy, "Programming in ANSI C", 8th Edition, 2019, McGraw Hill Education, ISBN: 978-93-5316-513-0.

Books for Reference:

- 1. Pradip Dey, Manas Ghosh, "Programming in C", 2nd Edition, 2018, Oxford University Press, ISBN: 978-01-9949-147-6.
- 2. Kernighan B.W and Dennis M. Ritchie, "The C Programming Language", 2nd Edition, 2015, Pearson Education India, ISBN: 978-93-3254-944-9.
- 3. Yashavant P. Kanetkar, "Let Us C", 16th Edition, 2019, BPB Publications, ISBN: 978-938728-449-4.
- 4. Jacqueline A Jones and Keith Harrow, "Problem Solving with C", Pearson Education. ISBN: 978-93-325-3800-9.
- 5. Dr. Guruprasad Nagraj, "C Programming for Problem Solving", Himalaya Publishing

House. ISBN-978-93-5299-361-1.

Weblinks and Video Lectures (e-Resources):

- 1. http://elearning.vtu.ac.in/econtent/courses/video/BS/14CPL16.html
- 2. https://nptel.ac.in/courses/106/105/106105171/

Outcomes

- > Students will be able to develop C programming to solve numerical problems
- > Programming skill will be developed.

			Semester	- I							
Course Co	de		IV- Foundati	on Course		T/P	C	H/W			
23BEL1FC			ındamentals fo			T	2	2			
Objectives				tro statistics and							
Objectives		To acquire knowledge on magnetism and Electromagnetism. Electro statistics, Potential and Electric current: Definition of point charge -									
				orce on a charge of							
Unit - I		potential - Definition of the electron volt Electric potential energy Charge q in a									
				- Parallel plate	capacitano	e - Ele	ctric	current			
		- Types of Electric current – Electric current generation.									
				g wire in a ma							
	magnetic	ield B-Force du	ie to B on cha	rge q moving wi	th velocity	y v-B d	ue to	a long			
Unit - II				solenoid - Ford							
			the Coulomb	and Ampere. Pro	operties of	Dia, P	ara a	nd fero			
	Magnetic										
	Electromagnetic Induction: Faraday's law of electromagnetic induction-Lenz's law-										
Unit - III	Induced emf and current- The inductance L-Energy stored in an inductor and energy										
	density in terms of B – Self Inductance – Mutual Inductance – Transformer – Electromagnetic waves - Maxwell's equation.										
	. Circuit Components: Ohm's Law – Resistance color code - Resistance Standard										
	for D.C. Low Resistance Standards Resistance Boxes- Inductance – Variable										
Unit - IV	inductances- Inductors for High Frequency Work- Inductors for Low Frequency										
	Work - Capacitance - Energy stored in a capacitance - Charge and discharge - RC time constants -Types of capacitances - applications of capacitances.										
				s (atomic numbe							
TT 4. TT	electron (charge, mass and spin) – orbits and energy levels – Electron shells - Bohr's										
Unit - V		model of the atom – Pauli's exclusion principle – Expression for the radius of the nth									
	possible orbit – velocity and energy of electron in this orbit – atomic bonds – Photo electric effect – Einstein's photo electric equation.										
T. (D. I		ect – Einstein's	photo electric	equation.							
Text Book		E1	13.6	0.01 1 1.0	т	, 1	ъ				
			ına Magnitism	, S.Chand and Co	ompany L	ımıted,	Kam	1			
	Nagar, Nev		In Electrical A	nd Electronic M		. + a A 1					
				and Electronic M							
				ducational And	recnnical	ruoiish	ers,				
1682,.NaiSarak Delhi-110006. 3. R. Murugesan, Modern Physics, S. Chand and Company Limited, Ram Nagar, New						Javy					
3. R. Murugesan, Modern Physics, S. Chand and Company Limited, Ram Nagar, New Delhi.						NEW					
 		G. 1 : 23	. 1:10	1			1				
Outcomes				undation in Elect	ronics by	learning	g abo	ut			
Jucomes	,	electricity, ma	agnetism, and	modern physics							

Course Code	e	Core Course II	T/P	C	H/W					
23BEL2C1		ELECTRONIC CIRCUITS	T	4	5					
	➤ To	apply the knowledge acquired to select various semiconductor	or diode	es to d	lesign a					
	rec	tifier and regulated circuits.								
	➤ To	To know the various biasing techniques to operate the transistor in various modes to								
Objectives	des	ign an amplifier, oscillator, and wave-shaping circuits.								
Objectives	➤ To	study and analyze various types of amplifiers for various applic	ations a	and to	acquire					
	kno	owledge to design an amplifier circuit.								
	➤ To	study various types of Oscillators and acquire knowledge to de	sign an	oscill	ator for					
		articular frequency.								
		iers, Filters and Regulators: Transformer –Rectifier - Half								
		rectifier - Bridge Rectifier - average value- RMS value-								
Unit - I	Efficie	ency - Comparison of Rectifiers - Filter - Inductor Filter - G	Capacit	or Filt	er – L-					
	section	n filter (LC filter) - π -section filter – Types of voltage regula	tors – Z	Zener	voltage					
	regula	tor – Transistor voltage regulator – Linear Mode Power supply.								
	Trans	istor Biasing: Need for biasing -Load Line Analysis - Fixed	Bias -	Emitt	er Feed					
	Back 1	Bias – Collector to Base Bias – Collector-Emitter Feedback Bi	as – Vo	ltage	Divider					
Unit - II	Bias -	- Common Base Stability - Stabilization Factor - Thermal 1	Runawa	ıy – 7	Thermal					
	Stabili	ty. FET biasing - Fixing the Q point - Self Bias - Voltage I	Divider	Bias -	- Fixed					
	bias.									
		Signal Low Frequency Transistor Amplifier: Analysis of			*					
	_	h- Parameters – Single Stage CE amplifiers – Single Stage CO			_					
Unit - III		stage CB Amplifier – CE amplifier with fixed bias – CE amplifier with Emitter resistor –								
	CE an	CE amplifier with Voltage divider – CB amplifier – CC or Emitter follower. Analysis of								
		signal FET Common Source Amplifier.								
	Large Signal, Feedback and Tuned Amplifiers: Class A Amplifier - Class B Push Pull									
		Amplifier and its efficiency - Basic concept of feedback - Effects of Negative Feedback-								
Unit – IV		Types of Feedback Connection - Stability of Feedback Amplifiers - RC coupled Amplifier								
		- Transformer Coupled Amplifier - Direct Coupled Amplifier - Small Signal Tuned								
	_	fier- RF Amplifier - Video Amplifier.								
		ators and Wave Shaping Circuits: Classification of Oscilla								
		Oscillation (Barkhausen Condition) - General form of LC Oscillator - Hartley Oscillator -								
Unit - V		Colpitts Oscillator - RC oscillator - Wien Bridge Oscillator - Crystal Oscillator -								
		ators using FET - UJT Relaxation Oscillator - Clipping and	Clampi	ing Ci	rcuits -					
	Multiv	vibrators.								
Text Book:	1 .	N. G 11	1.6'	• .						
		S., Sureshkumar, N., & Vallavaraj, A. (2008). Electronic Devices	and Cir	cuits.	Tata					
McGra	w Hill	Second Edition.								
Books for Re	eference	2:								
Jacob	Millmaı	n, & Christos C. Halkias.(1967). Electronic Devices and Circuits	McGra	aw-Hil	l1.					
Jacobl	Millman	, & Christos C. Halkias. Integrated Electronics and its Applicati	ions. Ta	ıta Mc	Graw					
Hill.										
	R S (20	13). A Text Book of Applied Electronics, S.Chand and Co Ltd,	Revise	d Edit	ion					
Bealla,	, ,	Students will be able to design and troubleshoot rectifiers and			1011					
		Students will be able to design and troubleshoot various type:			re lleine					
Outcomes		JT and FET.	s or all	hime	s using					
Outcomes		Students will be able to design and troubleshoot various typ	es of o	scillat	ore and					
		raveform generators	CS 01 0	sciiial	ors and					
<u> </u>	I W	averoriii generators								

Semester - II

		Semester - II			
Course Code:		Core Practical II	T/P	C	H/W
23BEL2P1		ELECTRONIC CIRCUITS LAB	P	4	4
Objectives	of rectified construct ref amplified ifferent tar	egulat	ors using		
2. Con 3. Con 4. Con 5. Con 6. Con 7. Con 8. Con 10. Con 11. Con 12. Con 13. Con 14. Con 15. Con 16. Con	struct of struct of struct of struct Tr struct Ro struct Pt struct RI struct Co struct Di	Half wave rectifier and study its parameters. Full wave rectifier and study its parameters. Bridge Rectifier and study its parameters. Volt Power supply with filter using Zener diode voltansistor voltage regulator. C coupled CE Amplifier and study its frequency respedback CE Amplifier and study its frequency response. ET Common Source Amplifier and Study its Frequency Response. Famplifier and study its frequency Response. In and Transformer Coupled Amplifier and Study its ideo Amplifier and Study its Frequency Response. In assessift Oscillator and calculate its frequency artley Oscillator and calculate its frequency collpitt's Oscillator and calculate its frequency in action of Clamper circuits and study its waystable Multivibrator using transistor and study its multivibrator using transistor and study its waystable multivibrator using transistor and study its multivibrator using transistor and study its waystable multivibrator using transistor and study its mul	sponse. nse. ency response Frequency	nse. Resp	RO.

19. Construct UJT relaxation Oscillator and study its wave form using CRO.

range of amplifiers.

wave shaping circuits

Outcomes

> Students will be able to design various types of rectifiers and choose which

Students will be able to design and troubleshoot rectifiers, filters and regulators.
Students will be able to design and troubleshoot various types and frequency

> Students will be able to design and troubleshoot various types of oscillators and

rectifier circuit is more suitable for a specific power supply design.

		Semester – II						
Course Code:		SEC - II	T/P	C	H/W			
23BEL2S1		PHOTONICS AND OPTOELECTRONICS	Т	2	2			
	> To und	erstand the principles, terminologies of LASER and cond	itions f	or LA	SER			
	> To und	erstand types of semiconductors and how the LASER action	on is ob	taine	ed			
Objectives	> To Uno	derstand types of semiconductors used to design LED at	nd stud	y its	working			
	functio	n and how to improve the wavelength of emission						
	> To stud	ly the various types of optical detectors and photovoltaic s	ystem					
Unit - I	Emission Emission Pumping	ntroduction to LASER: Basic principle of lasers – Absorption – Spontaneous Emission - stimulated emission - Einstein's Relation – Condition for Stimulated Emission – Condition for Light Amplification – Population Inversion – Pumping – Pumping Methods – Metastable State – The Principle Pumping Scheme - Laser rate quations for Two, Three and Four level Laser Systems.						
	Semicond	uctorLASER: LASER Diode Principle – LASER mode						
		ction Lasers -Modulation Response of ILD- ILD Str		- Di	stributed			
		Laser - Quantum Well Laser - Lasik Surgery and Hologram	_ •					
		play: LED- Basic Principle of Operation - Radiative Rec						
		etrostructure, Response time of LED - Carrier Configura n – ELED - SLED	ition an	a Mo	odulation			
		Plasma Display: Liquid Crystal Display - Construction	ı - Raci	c pri	nciple of			
Unit - IV		Plasma Display- Construction - Basic principle of emission		o pii	neipie of			
		Detector: Basic Principle of optoelectronic Detection		al al	sorption			
Unit - V	Coefficier	at and Photo Current -Quantum Efficiency - Responsivity	- Long	Wav	e Length			
Omt - v	Cut-off - s	silicon P-N photodiodes - Hetrojunction photodiodes - Sci	ojunction photodiodes - Schottkey barrier diode					
	- P-I-N pl	notodiodes- Avalanche Photo diode -Photo conducting De	etectors					
Text Books:	A) E:1							
		Optics and Optoelectronics (Unit-III and IV). Oxford Univ	•		T '4 T7)			
1		dita Thakur. (2011). Photovoltaic System Analysis and	d Desig	gn (U	J n it - V).			
Prentice H			. O. II. D	. •	TT 11 C			
	idhary Ric	ha Verma.(2011). Laser Systems and Applications (Unit-I	&II. Pr	entic	e Hall of			
India.	(200		III) G		T 1			
	• .	(i). Semiconductor Optoelectronic Devices (Unit III and	IV)- Se	cond	Edition.			
Prentice H								
 ➤ Knowledge will acquire to get LASER action in semiconductors and improve the optical wavelength by selecting the various semiconductor allow knowledge will acquire about hetrojunction semiconductor alloys to fabricate and LASER diode which will be useful for research ➤ Identify various types of optical detectors and know how it convert optical 				oys. cate LED				
		electrical energy ill give knowledge to design photovoltaic system.						
	/ It W	in give knowledge to design photovoltate system.						

		Semester - II								
Course Coo	de:	SEC - III	T/P	C	H/W					
23BEL2S2		SENSOR AND VIRTUAL INSTRUMENTATION	T	2	2					
Objectives	ectives Acquire knowledge of various sensors Acquire virtual instrumentations system development program.									
Unit - I	Sensors Measuren Measuren	Sensors & Transducer: Definition, Classification & selection of sensors, Measurement of displacement using Potentiometer, LVDT & Optical Encoder, Measurement of force using strain gauge, Measurement of pressure using LVDT based diaphragm & piezoelectric sensor.								
Unit - II	RTD, Co sensors, l accelerom	Measurements: Measurement of temperature using Thermistor, Thermocouple & RTD, Concept of thermal imaging, Measurement of position using Hall effect ensors, Proximity sensors: Inductive & Capacitive, Use of proximity sensor as accelerometer and vibration sensor, Flow Sensors: Ultrasonic & Laser, Level Sensors: Ultrasonic & Capacitive.								
Unit - III	Advantag Arrays, C	nstrumentation: Graphical programming techniques, Date of Virtual Instrumentation techniques, Concept of WHI lusters & graphs, Structures: Case, Sequence & Formula passed instruments for industrial automation.	LE & I	FOR						
Unit - IV	Data Acq Timers, T	uisition Methods: Basic block diagram, Analog and Dig ypes of ADC: successive approximation and sigma-delta Resistor and R-2R Ladder type, Use of Data Sockets for	, Types	of D						
Unit - V	Character	t Sensors: General Structure of smart sensors & istic of smart sensors: Self calibration, Selftesting & son of smart sensors: Automatic robot control & automobi	elf-con	nmur	icating,					
D P S. C Inst	S Murthy, Satranabis, Supta, J.P. Grument Socreta	Transducers and Instrumentation, PHI 2nd Edition 2013 Sensors and Transducers, PHI 2nd Edition 2013. Gupta / PC interfacing for Data Acquisition & Process Cociety of America, 1994. / Lab VIEW Graphical Programing II Edition / McGraw	ontrol,	2nd I						
Books fo Arui 2012 A.D Tech	or Reference or K. Ghosh 2. . Helfrick a nniques, Ph	ce: , Introduction to measurements and Instrumentation, PHI and W.D. cooper, Modern Electronic Instrumentation & M	I, 4th E Ieasure	dition ment	t					
Pres Outcomes	s.	Students will be able to select the suitable sensor applications.	s for	the 1	equired					

		Semester - III					
Course Co	de:	Core Course V	T/P	C	H/W		
23BEL3C1		DIGITAL ELECTRONICS	T	4	5		
Objectives	c k k T T T T T T T	To know how the computer performs arithmetic operation omplement system. Apply theorems and algebra to design and minimize the larnaugh map To develop the skill to handle and design combinational left ounderstand the function of flip-flops and to know equential logical circuits using flip-flops	ogical	circu circui	it using		
Unit - I	Minimiza and 2's Co Algebra – Technique	tion Techniques: Number Systems – Floating Point R omplements – Signed number Addition and Subtraction Demorgan's Theorem – Canonical and Standard Form s – Simplification of Boolean Functions using Karnaugh	– Code ns – N Map.	s – I Iinin	Boolean nization		
Unit - II	Adder – I Divider – Encoder –	tional Logic Design: Logic Gates – Universal Gates – Half Subtractor – Full Subtractor – BCD Adder – Bin Multiplexers – De multiplexers –(74138) 3 to 8 Decode BCD to Seven Segment Decoder 7447/48 – Parity Gene	ary M er – 74 rator ar	ultipl 148 nd Ch	ier and Priority neckers		
Unit - III	Flip-Flop	Flip-Flops: Basic Latch circuits – S-R Flip-Flop – D Flip-Flop – J-K Flip-Flop – T Flip-Flop – Triggering of Flip-Flops – Asynchronous Inputs in Flip-Flops – Master Slave J-K Flip Flops – Racing Condition .					
Unit - IV	Counter – S – BCD De	Counters And Registers: Asynchronous Counters: Ripple Counter – Decade Counter – Synchronous Counters: Up/Down Counter – Design of MOD- n Counters – BCD Decade Counter – Ring Counter - Registers: 4- bit Shift Register – SISO Shift Register – SIPO Shift Register – PIPO Shift Register.					
Unit - V		A/D Convertors: Basic DAC Techniques – Weighted In Type DAC -Monolithic DAC 0808 –Successive App 3.					
Books for I	Electronics, Reference:	S.Salivahanan, S.Arivazhagan, Vikas Publishing -2012 Morris Mano - Pearson Education (3rd Edition)					
Digital P	Principles –	Leach, Malvino, TMH (6th Edition).					
Fundame	ental of Dig	ital Circuits- Anand Kumar- Prentice Hall of India Pvt. I	Ltd.				
Digital E	Electronics –	- Dr. R. S. Sedha – S. Chand Publications.(3rd Revised E	dition)	•			
Outcomes	s >	Students will be able to use logical gates, universal gate circuits. Students will be able to use mux,dmux,encoder and digital circuit using microprocessors and microcontroller Students will be able to develop the skill to design comb	decode	er to	design		

		Semester - III						
Course Code	e:	Core Course VI	T/P	C	H/W			
23BEL3P1		Digital Electronics Lab	P	4	4			
		nderstand the pin details of digital IC's and function of e	ach log	ic ga	tes with			
		elp of the verification of truth table.						
Objectives		nderstand how the universal gates are used to design vari	_	_				
		esign combinational and sequential logical circuits using	logical	devi	ces and			
		us flip-flops respectively						
		ogic Gates Using IC's and verify its truth table						
		esign Logic gates using Universal NAND gate and verify						
		esign Logic gates using Universal NOR gate and verify it		table				
		esign and Implementation of Code conversion using logic	•					
		5. Implementation of Half Adder and Full Adder using logic gates.						
	6. Implementation of Half Subtractor and Full Subtractor using Logic Gates.							
	7. Implementation of SOP and POS logical functions using universal gates.							
	8. Implementation of Half Adder and Full Adder using logic gates.							
	9. Implementation of Half Subtractor and Full Subtractor using Logic Gates							
Unit - I		implementation of Binary Adder and Subtractor using IC	7483					
Cint - 1		Verification of Functionality of Multiplexer						
		Verification of Functionality of De multiplexer						
		Verification of functionality of Decoder.						
		Verification of functionality of Encoder.						
		Verification of the functionality of BCD to Seven segmen		der/d	river.			
		mplement S-R, D, J-K, T flip flops using logic Gates/IC						
		Functional verification of universal shift registers using I						
		Design and implementation of Ring counter using shift re	gister.					
		Design and Implementation of 4 Bit Ripple counter						
		Mod Counter/decade counter						
		ents will be able to use digital IC's using their pin de	etails ar	nd op	perating			
	volta	•						
Outcomes		ents will be able to use mux, demux, encoder and deco	der who	ere e	ver it is			
Jucomes	•	red in digital circuit design.	_					
		ents will be able to design combinational logical circ	uits an	d sec	quential			
	logic	al circuits						

Course Code:		SEC - IV	T/P	C	H/W		
23BEL3S1		ELECTRONIC INSTRUMENTATION	T	2	2		
	➤ To	understand how to design a system to give high accu	racy ar	nd m	inimize		
	vari	ous errors					
Ohioativos	➤ To	understand types of bridge circuits used for various	physica	al pa	ramete		
Objectives	mea	asurements.					
	> To	understand design and working principles of im	portant	me	easuring		
	inst	ruments used to measure the parameters in an electronic	circuit.				
	Measu	rement Principles: Measurement of physical parame	eters- N	Ieası	ıremen		
Unit - I	system	block diagram- Measurement Characteristics like A	ccuracy	, Pr	ecision		
	Sensiti	vity, Linearity, Resolution, Reliability, Repeatability - En	rrors.				
Unit - II	Bridge	es: DC Bridge: Wheatstone Bridge – AC Bridges and T	heir Ap	plic	ations -		
Unit - II	Maxwo	ell Bridge – Hay Bridge – Wien Bridge					
	Test and Measuring Instruments: Working Principle, Block diagram,						
Unit - III	Specification and Operating procedure for: Voltmeter -Ammeter - Analog						
	Multin	neter - Electronic Voltmeter- LCR Meter.					
	CRO:	Introduction to Oscilloscopes - Cathode ray tube- vert	tical an	d ho	rizonta		
Unit - IV	deflect	ion system- delaylines - oscilloscope probes - elem	entary	idea	s abou		
	storage and sampling oscilloscope- Applications of oscilloscope.						
	Signal	Generation And Test Systems: Audio Oscillator- Fu	ınction	Gen	erators		
Unit - V	Pulse	Generator - RF Generator - Sweep generator- Random	Noise	Gene	erator -		
	Freque	ency Analyzer.					
Books for Ref	erence:						
Alber D.	Helfric	k, & William D.Cooper. (2012). Modern Electronic Instr	umenta	tion	and		
measuren	nent tec	hniques. PHI.					
Bouwens	s, Digita	al Instrumentations. TMH					
Kalasi, F	I. S. <i>Ele</i>	ctronic Instrumentation.TMH					
Rangan,	C. S., S	arma, G. R., & Mani, V. S. V. (1983). Instrumentation: a	levices	and			
_							

Sawhney, A. K., & Sawhney, P. (2016). A course in Electrical and Electronic

> Skill will be developed to handle various measuring instruments to measure the physical parameters and wave form generators to trouble shoot an electronic

Measurements and Instrumentation. Dhanpat Rai & Company.

instrument.

systems.TMH.

Outcomes

		Semester - III					
Course Code:		SEC - V	T/P	C	H/W		
23BEL3S2		Digital Logic with VHDL Design	T	2	2		
Objectives	> Acq	uire knowledge to design digital circuits using CMOS					
Objectives	> To a	To develop the skill on VHDL programming for VLSI design.					
	l	Oxide Semiconductor (MOS): Introduction to basic					
Unit - I	1	tor -CMOS inverter - Large Signal MOS Models (long		/	_		
	_	MOS SPICE model, MOS device layout: Transistor lay S digital circuit layout.	out- In	verte	r layout		
		Inverter: Inverter principle - Depletion and enhancemer	ıt load i	nver	ters- the		
Unit - II		basic, transfer characteristics- logic threshold- Noise margins- Dynamic behavior-					
	Propag	ation Delay and Power Consumption.	_				
	Combinational MOS Logic Design: Static MOS design- Pass Transistor logic-						
Unit - III	complex logic circuits. Sequential MOS Logic Design - Static latches, Flip flops						
		ers-Dynamic Latches & Registers.	D.:.4	. D			
		Programming: Introduction to VHDL - Module, Delay			•		
		Flow Style- Behavioral Style-Structural Style-Mi		_	•		
Unit - IV		Simulating Design- Language Elements: Keywords- Identifiers- White Space					
		ters- Comments- Format- Integers- Reals and Strings.	-				
	Types-	Net Types- Undeclared Nets-Scalars and Vector Ne	ts- Reg	giste	r Type-		
	Parame	eters- Operands- Operators- Types of Expressions					
	VHDL	Modeling: Gate Level Modeling - MOS Switches, Bid	irection	al Sv	witches-		
Unit - V	Gate]	Delay- Array Instances, Implicit Nets- Illustrative	Exan	nples	(Both		
	Combi	national and Sequential Logic Circuits)					
Toxt Dools							

Text Book:

- 1. Kang&Leblebigi "CMOS Digital IC Circuit Analysis & Design"-McGraw Hill,2003.
- 2. Rabey, "Digital Integrated Circuits Design", Pearson Education, Second Edition, 2003.
- 3. Weste and Eshraghian, "Principles of CMOS VLSI design" Addison-Wesley, 2002.
- 4. Basic VLSI design: Douglas A Pucknell, Kamran Eshraghian, PHI, 3rd edition
- 5. A VHDL Primer By J.Bhasker, 3rd edition PHI, New Delhi, 2007
- 6. Circuit design with VHDL by Volnei. Pedroni PHI, New Delhi, 2007
- 7. Digital Systems Design using VHDL by Charles H.Roth Jr.- PWS Pub.,1998
- 8. Fundamentals of Digital Logic with VHDL Design by Stephen Brown and Zvonko Vranesic TMH. 2002

Outcomes > Skill will be developed to develop VHDL programming

		Semester - IV						
CC/DSE/NME	,	Core - VII	L	T	P	С	H/W	
Course Code:		ANALOG INTEGRATED CIRCUITS		T		4	5	
23BEL4C1								
Objectives	l	study IC fabrication techniques						
	l	know the pin details, power supply				nd v	/arious	
	app	lications of OP-AMP to perform mathematical	al ope	eratio	ons			
	➤ To	design various function generation techniques	s usir	ıg Op	o-An	ıp		
	> To	design voltage regulators and filter circuits us	ing (Op-A	mp			
	≻ To 1	know 555 timer and its applications						
Unit - I	Planar	· Ic Fabrication Processes: Classification of	f IC's	s - Si	licor	ı Wa	fer	
		$ation-Epitaxial\ Growth-Oxidization-Pho$					fusion	
		mplantation – Isolation Techniques – Metallis						
		sing and Packaging – Fabrication of NPN Tr						
	l	ication of Resistance, Inductance and Capacit	ance	– Su	rtace	e Mo	unting	
Unit - II	Techno	ology. tional Amplifiers: IC 741 Op-Amp Termina	1 ₀ T	Darria	. C.	1xx		
Onit - II		ctions – Ideal Op-Amp – Negative Feed Back					CS	
		Voltage Follower - Inverting Amplifier – Non inverting Amplifier –						
		Inverting Summing Amplifier – Non inverting Summing Amplifier –						
		Differential Amplifier – Integrator – Differentiator - CMRR –						
	Instrumentation Amplifier- Sample and Hold Amplifier.							
Unit - III	Comparators and Waveform Generators: Comparator – Zero Crossing							
	l	Detector – Schmitt trigger – Phase Shift Oscillator – Wien Bridge Oscillator						
		re Wave Generator (Astable Multivibrator) –						
	l	ibrator- Triangular wave Generator – IC XR	2206	Wav	etor	m		
Unit - IV	Genera	uor. g e Regulator and Active Filters : Voltage R	2011	2+2#1	10100	70		
Onit - IV		oltage Regulator using IC – Variable Voltage						
	l	ching Regulator – RC Active Filter: First order	_			_	, 123	
		Order Active Filter – Higher Order Low Pa					S	
	l	Filter-Band pass Filter – Band Reject Filter –			_	•	J	
Unit - V		MER and PLL: 555 Timer Pin Details – Details					onal	
		Diagram – Monostable Operation – Astable O						
		ntor – Pulse Position Modulator – Schmitt Tri					ples	
		– IC PLL 565 – Frequency Multiplication/D	ivisio	on –	AM/	FM		
Tarak Daraha	Detect	ion – FSK Demodulator.						

Text Book:

1. Linear Integrated Circuits, D.Roy Choudhury, Shail B. Jain, New Age International Publishers, Fourth Edition – 2010.

Books for Reference:

- 1. Op-Amps and Linear Integrated Circuits, Ramkant A.Gayakward, PHI 2005
- 2. Operational amplifiers and Linear Integrated circuits, R. F. Coughlin and F. F. Driscoll, Pearson Education -2001
- 3. Integrated Electronics, J. Millman and C.C. Halkias, Tata McGraw-Hill 2001
- 4. Electronic Principles A.P.Malvino,6th Edition, Tata McGraw-Hill -2003

5. OP	P-AMP and Linear Integrated Circuits, K.L.Kishore, Pearson- 2011
Outcomes	➤ Students will be able to handle 741 IC's for various applications
	> Students will be able to design a circuit for wave form generation, voltage regulation and filter
	> Students will be able to handle 555 timer for square wave and pulse generation.
	> Students will understand the function of PLL

		Semester -	IV					
CC		Core Practical		L	T	P	С	H/W
Course Code: 23BEL4P1		ANALOG INTEGRATI LAB	ED CIRCUITS			P	4	4
Objectives		knowledge to connect Op-A			-			
		nderstand how the Op-Am	-	_	-		S	
		nderstand how the 555 time now how the Op-Amp perf	_		mode	es		
	7 10	now now the Op-Amp peri	orm mer operanc)118				
		1. DC Characteristics of C	OP-Amp					
		2. Inverting and Inverting	Summing Amplif	ier				
		3. Non Inverting and Non	Inverting Summin	ng A	mpli	fier		
		4. Differential Amplifier						
		5. Voltage Follower and I	nstrumentation Ar	nplii	fier			
		6. Differentiator and Integ	grator using OP-A	mp				
		7. V to I and I to V conver	rtor					
		8. Construct Peak Detector	or					
		9. Construct Comparator a	and Zero Crossing	Det	ectoi			
		10. Schmitt Trigger						
		11. Construct Op-Amp Squ	are Wave Genera	tor				
		12. Construct Op-Amp Wie	en Bridge Oscillat	or				
		13. Construct Waveform G	enerator using XR	220	6			
		14. Construct Audio Ampli	ifier using LM 320)				
		15. Construct Voltage regu	lator using 78XX]					
		16. Construct Dual Voltage	e Regulator using	78X	X and	d 792	XX	
		17. Construct variable Pow	er supply using IC	723				
		18. Construct Astable Mult	ivibrator using 55	5 Ti	mer			
		19. Construct Monostable I	Multivibrator usin	g 55	5 Tir	ner		
		20. Construct VCO using N	NE 566					
Outcomes		ents will be able to develo	•	ndle	Op-A	Amp	for v	arious

	Semester – IV						
Course Code:	SEC - VI	T/P	C	H/W			
23BEL4S1	MICROPROCESSOR PROGRAMMING AND INTERFACING TECHNIQUES	T	2	2			
Objectives	 To know the architecture, pin details and programming control signals using logical digital circuits. To develop assembly language programs for simple appl the skill to interface peripheral devices using programmab with 8085 microprocessor. To study various programmable interfacing peripheral interrupt and serial communication. 	ications le perip	and oheral	develop devices			
Unit – I	8085 Architecture And Programming: The 8085 Micropro 8085 Architecture –, Microprocessor initiated operations and Demultiplexing AD0-AD7 – Generation of control Signals – of 8085 – Instructions and timing – addressing modes Programming techniques – Simple Programs.	d bus C Prograr – Instr	Organiz nming uction	zation - Model Set -			
Unit – II	Interfacing I/O Devices Using 8255: Basic Interfacing Mapped I/O – I/O mapped I/O – Memory Interfacing – Progra			•			
Unit – III	Programmable Peripherals interfacing: DMA Data Transf DMA Controller-8085 Interrupts – Interfacing 8259.	1 0					
Unit – IV	Serial Data Communication : Interfacing 8251 and RS 232 – 8253/54 Timer and Counter.						
Unit – V	I/O Interfacing Techniques: LED interfacing – DIP Switch Interfacing – Seven Segment Display Interfacing Stepper Motor –interfacing – Hex Key Board –ADC Interfacing – DAC Interfacing – Temperature controller.						
Text Book:							
	S. Goanker. <i>Microprocessor Architecture, programming and Aparam</i> International Publishing, 5 th Edition (Units I, II, and III).	pplicati	ons wi	ith the			
Outcomes	 Students will be able to develop the skills to write an own programming Students will be able to understand the interfacing concept to interface the programmable interfacing peripherals at various programmable devices to perform data transfer devices. Students will be able to develop the hardware and Programming skill for 8085 microprocessor system 	and devoded and co	velop t gramm ntrol	the skill ing the the I/O			

		Semester - IV						
Course Code:		SEC -VII	T/P	C	H/W			
23BEL4S2		MEDICAL ELECTRONICS	T	2	2			
	\ T			1 .				
		o understand the origin of bioelectric signals and elect	rodes us	sed to	pick up			
		e signal for analysis.			,			
		o understand ecg signal recording system and identified		s com	ponents			
Objectives		quired to design ECG recorders using various lead syst			1.1			
3		o understand the origin of EEG wave and study its cha	iracteris	tics an	id know			
		ow to fix the electrodes to pick up the EEG signals.		·c 1	, .			
		o understand function of pacemaker fibrillators and		iry ei	ectronic			
		omponents required to design various types of pacemak						
		lectric Signals and Electrodes: Origin of Bio Electri						
Unit - I	of Ions through Cell Membrane – Resting Potential – Action Potential –							
	Electrodes – Half Cell Potential – Electrode Jelly Interface – Micro Electrode – Needle Electrode – Surface Electrode.							
			1 T	1. T	11			
II		ECG Recorders: ECG- ECG Lead Configuration – Bipolar Limb Leads – Augmented Unipolar Limb Leads – Uni Polar Chest Leads – ECG Recorder						
Unit - II	_	•	ius – E	CG K	ecorder			
		Setup – ECG wave form and its Characteristics -	Irad Dat	ontial	Duoin			
Unit - III		Recorder: EEG – Origin of EEG – Action and Evol	keu Pou	emnai	– Brain			
		 Placement of Electrodes – EEG Recording Setup Dogical Assist Devices: Pacemakers – Energy Require 	manta ta	Evoi	ta IIaant			
		e – Methods of Stimulation – Modes of Opera						
Unit - IV		hronous Pacemaker – Ventricular Synchronous pacem						
Unit - IV		of Defibrillators – DC Defibrillator – Synchronized I						
		Defibrillator.	Jenonii	a101 –	Square			
		Electrical Parameter Measurement: Temperatu	ıra ma	ocurar	nent			
		atory Measurement – Heart Rate and Pulse rate M						
Unit - V		re Measurement – Ultrasonic Blood flow meter						
		uction to bio telemetry system.	- 110	armg	Alus			
Toyt Dooles	muout	action to old telementy system.						

Text Books:

Arumugam, M.(1997). Bio Medical Instrumentation. Anuraha Publications.

Khanpur, R.S. (2003). *Hand Book of Bio Medical Insturmentation - Second Edition*. Tata McGraw Hill

Rakesh Kumar. (2007). Bio-Medical Electronics & Instrumentation. S. K. Kataria & Sons.

Venkata Ram, S.K. (2000). *Biomedical Electronics and Instrumentation-First Edition*. Galgotia Publications Pvt.Ltd.

Books for Reference:

Joseph J.Carr. (2001). *Introduction to Biomedical Equipment Technology- Fourth Edition*. Pearson Education.

Leslie Cromwell. (2013). Biomedical Instrumentation and Measurements- Second Edition. PHI Pvt. Ltd.

Outcomes Noutcomes Knowledge will be acquired the origin of bioelectric signals ECG, EEG and identify the types of electrodes used to pick up the signal for analysis. Knowledge will be acquired the characteristics of ECG and EEG signal for analysis and identified the electronics components and circuits needed. Able to design pacemaker and defibrillator circuits Able to design a biotelemetry system

	Semester – V	_	_			
Course Code:	Core Course IX	T/P	C	H/W		
23BEL5C1	EMBEDDED SYSTEM DESIGN	T	4	5		
Objectives	 To understand embedded system, embedded hardware and some the difference between microprocessor and mic architecture To study the features, architecture, Programming model, embedded coding using embedded C To acquire knowledge to programming I/O ports communication and interrupt To acquire skill to interface I/O devices with 8051 microcommunication 	rocontr how to s, Tin	oller			
Unit – I	8051 Architecture: Features of 8051 – Pin description Microcontroller Architecture – 8051 oscillator and clocks – P data pointer – A and B Registers – Bank Registers –Flags –PS – Stack and Stack pointer – special Function Registers - mer External Memory Interface.	of 80 rogram W - Ir	cour nterna	nter and al RAM		
Unit – II	Programming Parallel I/O Ports and Interrupts: Programm C- 8051 Parallel I/O Ports – Port 0 – Port 1- Port 2 – Programming – I/O bit manipulation Programming – Initializing 8051 Interrupts – Interrupt Priority	Port	3- I/	O Port		
Unit – III	Programming Timers/Counters And Ext. Interrupts: Timers and Counters — Timer and Counter Modes — Mode 0- Mode 1 — Mode 2 — Mode 3 Programming 8051 Timers — Counter Programming — Programming Timers 0 and 1 in 8051 — Programming Timer Interrupts — Programming External Hardware Interrupts.					
Unit – IV	Programming Serial Communication: Serial Communication — Serial Communication Modes — Basics of serial communication — 8051 connection to RS232 - 8051 serial Port Programming — Programming the serial communication interrupt- AT commands					
Unit – V	Interfacing Techniques: LED Interfacing – DIP switch Interfacing – DIP switch Interfacing – Traffic controller interfacing Interfacing – DC motor Interfacing and PWM - Key board display Interfacing - Interfacing LM 35 temperature sensor ADC Interfacing– sensor interfacing – GSM interfacing.	g – Ste interfac	epper eing -	Motor LCD		
Text Books: Kenneth J. Ay	ala. (2004). The 8051 Microcontroller Architecture, Programmi	ng and				
Applicati	ons, Penram International Publication, Second Edition -2004.					
Mohammed Al	i Maszidi. (2006). The 8051 Microcontroller and Embedded Sys	tems us	ing			
Assembly	and C. Prentice Hall of India, Second Edition.					
Outcomes	 able to handle various IDE for embedded programming Able to design hardware Able to enable I/O ports, serial communication using time embedded programming 	ers and	inter	rupt by		

- ➤ Able to develop embedded software
- ➤ Able to download the firmware in flash memory of the microcontroller to operate their own embedded system

	Semester - V						
Course Code:	Core Course X	T/P	C	H/W			
23BEL5C2	ELECTRONIC COMMUNICATION SYSTEM	Т	4	5			
Objectives	 To understand electromagnetic wave propagation of propagations To understand how does an antenna transfelectromagnetic waves and study various type applications. To understand Analog communication, need for types of AM modulation generation. To understand the function of AM transmitters and To understand FM and PM, Generation of FM, transmitter and receiver. To understand digital communication, digital transmit and various shift keying in digital communication. 	mit and sof a modureceive Detect	nd 1 anten ilatio	receive the ana and its on, different of FM, FM			
Unit – I	Wave Propagation: Block diagram of Communication sy Spectrum – Electromagnetic Waves - Frequency and atmosphere – Radio wave Propagation – Ground wave – ic wave – Troposphere Wave – Maximum Unusable Frequency Unusable Frequency (LUF)	d Wav	e ler ere w	ngth – The ave – Space			
Unit – II	Antenna: The isotropic radiator – The Half wave dipole – Impedance and radiation resistance – Radiated Power and Efficiency – Antenna gain – The Yagi Beam antenna – Directional Characteristics – Other practical antenna – Feeders – Connectors – Standing wave ratio – Wave Guide.						
Unit – III	Amplitude Modulation: Need for Modulation – Amodulation index and frequency spectrum - General Modulation) - Amplitude Demodulation (diode detector Suppressed Carrier generation Balanced Modulator – Standard Modulator – Standard Modulator – Standard Modulator – Standard Modulator – Amodulation –	ntion o)- Dou SBSC	of A uble gener	M (Emitter Side Band ration Filter			
Unit – IV	Angle modulation: Frequency and Phase modulation, frequency spectrum, equivalence between FM and PM- G and indirect methods)- FM detector (Balanced Slope diagram of FM Transmitter and Receiver Comparison between	eneration Detector	on of or, P	FM (direct LL). Block			
Unit – V Reference Boo	Digital Carrier Modulation Techniques: Channel capace PAM- PDM –PPM modulation and detection techniques. FDM- Block diagram of digital transmission and reception Bit Rate, Baud Rate and M-ary coding- Amplitude Frequency Shift Keying (FSK)-Phase Shift Keying (PSI Keying (BPSK) - Quadrature Phase Shift Keying (QPSK)	Multipl n- Infor Shift	exing mati Keyi	g- TDM and on capacity, ing (ASK)-			
Kelerence Buc	ya.						
Couch, L.W. (2	2005). Digital and analog communication systems. Pearson I	Educati	on.				

Frenzel, L. E. (2002). Communication electronics: Principles and applications. TMH.

Hsu, H.P. (2006). Analog and Digital Communication. Tata McGraw-Hill.

Kennedy, G., & Davis, B. (1999). Electronic communication systems. TMH.

Singh, R. P., & Sapre, S. D. (2008). Communication Systems, 2E. Tata McGraw-Hill Education.

Thomas, T.G., & Chandra Sekhar, S. (2006). Communication theory. Tata McGraw Hill.

Tomasi, W. (2007). Electronic communication systems: Fundamentals through Advanced. Pearson Education.

Outcomes > S

- > Students will be able to know EM wave and its various propagation
- > Student will be able to choose which type of antenna should be used in different transmission and detection applications.
- > Student will be able to choose which type AM modulation is required for radio, TV and other applications.
- > Student will be able to differentiate AM, FM and PM modulation and know FM transmission and reception.
- > Student will be able to understand the advantage of digital communication and analog communication and also sampling and shift keying techniques used in digital communication.

Core Course XI POWER ELECTRONICS The construction, working function, modes of istics of the power electronics devices and its turn various types of commutation techniques to turn how thyristors operates as a rectifier and use and SMPS circuits.	n on mec	hanisı thyrist	ms.		
the construction, working function, modes of the power electronics devices and its turn various types of commutation techniques to turn how thyristors operates as a rectifier and use and SMPS circuits.	of operarn on med	tions chanisi thyrist	and its ms.		
various types of commutation techniques to turn how thyristors operates as a rectifier and use and SMPS circuits.	n on mec	hanisı thyrist	ms.		
		sign i			
etronic Devices: SCR Characteristics – Two Parallel connections of SCRs – Gate Characterist a and working –V-I Characteristics – TRIA Modes of Operations –Thyristors Turn ON Metho	stics of S AC Cons	SCR -	- DIAC		
Firing Circuits : Diode-Resistance Firing Circuit. Diode-Resistance-Capacitance Firing Circuit. UJT Firing Circuit. Pulse Transformer Firing Circuit Diac Firing Circuit.					
Commutating Circuits: Line Commutation- Load Commutation- Forced Commutation- Gate Turn-off Voltage Commutation- Current Commutation-Pulse Commutation – Overvoltage Protection –Over current Protection –Gate Protection – Over temperature Protection.					
Rectifiers: Half-Wave Controlled Rectifier w Controlled Rectifier with Resistive and Inducti Rectifier with Inductive Load and Flywhere	ive Load	l- Hal	f-Wave		
mage recuirers.	verters. hopper–§	Switch	Mode		
Ť.	ter Bridge Inverters – Pulse -Width Modulated Inv Principle of a Chopper voltage commutated C	Thopper and Switch Mode Regulator: -Sine Wave Inveter Bridge Inverters – Pulse -Width Modulated Inverters. Principle of a Chopper voltage commutated Chopper–S	Chopper and Switch Mode Regulator: -Sine Wave Inverter – ter Bridge Inverters – Pulse -Width Modulated Inverters. Principle of a Chopper voltage commutated Chopper– Switch Buck Regulator – Boost Regulator- Buck-Boost Regulator-		

Books for Reference:

Mohan, N., Undeland, T. M., & Robbins, W. P. (2003). *Power electronics: converters, applications, and design.* John wiley & sons.

O.P. Arora. (2007). Power electronics Laboratory: theory, Practice & Organization. Narosa Publishing house.

Rashid, M.H. (2004). *Power electronics: Circuits, Devices and Applications, third Edition.*Pearson Education

Sen, P. C. (1987). Power electronics. Tata McGraw-Hill Education.

		Able to design circuit to turn on and turn off the thyristors.
Outcomes	>	Able to use thryristors to design rectifier, inverter, chopper and SMPS circuits
		and get idea to trouble shooting the power electronics circuits.

	Semester – V								
Course Code:	Core Practical XII	T/P	C	H/W					
23BEL5P1	Embedded System Design , Communication and	P	4	5					
	Power Electronics LAB								
	Any Twelve Experiments								
	> To learn the logics how to write a programme for code conversion								
	> To learn the interfacing techniques to design a hardware								
	> To learn how to work on various IDE								
Objectives	> To develop embedded C programme								
	> To know how to down load firmware in the flash memor	y using p	rogran	nmer					
	> To Study various modulation and demodulation technique	es							
	To study the characteristics of thristors								

- 1. BCD to ASCII and ASCII to BCD.
- 2. Decimal to Hexa and Hexa to Decimal.
- 3. Interfacing with DIP switches and LED
- 4. Interfacing with Seven Segment LED
- 5. Interfacing with Traffic Light controller.
- 6. Interfacing with Stepper Motor
- 7. Interfacing with DC Motor speed control using PWM
- 8. Interfacing with HEX Keyboard
- 9. Interfacing with LCD
- 10. Interfacing with DAC
- 11. Generate wave forms using DAC
- 12. Interfacing with ADC.
- 13. Serial communication using RS232
- 14. Interfacing LM35 with LCD
- 15. Interfacing sensor with LCD
- 16. Interfacing GSM with LCD
- 17. Interfacing Blue tooth module with Android App
- 18. DSB Amplitude Modulation and Demodulation
- 19. Frequency Modulation and Demodulation
- 20. Pulse Amplitude Modulation
- 21. Pulse Width Modulation
- 22. Amplitude Shift Keying
- 23. Frequency Shift Keying
- 24. PLL Parameters using NE 565.
- 25. SCR Characteristics
- 26. DIAC Characteristics
- 27. TRIAC Characteristics
- 28. UJT relaxation oscillator

- 29. SCR is used as a Relay
- 30. SCR Fire alarm circuit

Outcomes

- ➤ Able to work on IDE and generate the firmware
- > Able to download the firmware in the flash memory of the controller
- > Identify the required components to design the embedded system and able to design the hardware.
- ➤ Able to develop embedded software for the given hardware to enable the embedded system.
- > Able to design various modulation and demodulation techniques
- ➤ Able to design circuit to use SCR for some applications

		Semester - V						
Course Code:		DSE - I	T/P	C	H/W			
23BEL5E1		INTERNET OF THINGS WITH ARDUINO	Т	3	4			
	➤ To	understand Smart Objects and IoT Architectures						
	➤ To	learn about various IOT-related protocols						
Objectives	➤ To	build simple IoT Systems using Arduino						
	➤ To	understand data analytics and cloud in the context of	IoT					
	➤ To	develop IoT infrastructure for popular applications						
	Introd	luction: Introduction to Internet of Things: Cha	aracter	istics	of IoT-			
Unit - I	Design	n principles of IoT - IoT Architecture and Pro-	otocols	s -	Enabling			
	Techno	ologies for IoT- IoT levels - IoTvs M2M						
	Sensor	rs and IoT Design Methodology: Classification of	Senso	ors -	Working			
Unit - II	Princip	ble of Sensors - Criteria to choose a Sensor -Gen	eration	n of	Sensors-			
Unit - II	Design	Design methodology- Challenges in IoT Design- IoT System Management - IoT						
	Server	s						
	Basics	s of Arduino: Introduction to Arduino – Arduino Un	10 –A1	duin	o Mega -			
Unit - III	Arduino Nano -Steps to installArduino IDE- Steps to write a program with							
	Arduino IDE – Basic commands for arduino							
	Interfa	cing with Arduino						
	Arduino: Interfacing LED - Interfacing LCD using various protocol -							
IImit IV	interfacing relay - Play with Digital Sensor - Play with Analog Sensor -							
Unit - IV	Interfa	cing with DC motor - interfacing with Stepper motor	or – in	terfa	cing with			
	Servo	motor - Interfacing with GSM - Interfacing with Blu	e tooth	ı – Ir	terfacing			
	with R	F modem(2.4GHz)						
	Conne	ecting to the Cloud: Smart IoT Systems: DHT1	Data	Log	gger with			
Unit - V	Thing Speak Server- Ultrasonic Sensor Data Logger with Thing Speak Server -							
Unit - V	Air Q	uality Monitoring System and Data Logger with Th	ning S	peak	Server -			
	Smart Motion Detector and Upload Image to gmail.com							
Text and Refe								
Raspberry Pi a	nd Ardu	ino. CRC Press.						
_	lot, A.,	Gupta, L. R., Singh, B., & Swain, M. (2019). Internet	of thin	gs w	ith			
Singh,								
	R., Gehlot, A., Singh, B., & Choudhury, S. (2017). Arduino-based embedded systems: interfacing, simulation, and LabVIEW GUI. CRC Press.							
	> Ana	lyze various protocols for IoT						
	➤ Dev	elop web services to access/control IoT devices.						
Outcomes		ign a portable IoT using Arduino						
		loy an IoT application and connect to the cloud.						
	➤ Ana	lyze applications of IoT in real time scenario						

	Semester – V							
Course Code:	DSE - II]	Г/Р	C	H/W			
23BEL5E2	COMPUTER NETWORKING		T	3	4			
Objectives	 To study OSI layers and understand digital data communication and its requirements To study various data link control protocols To understand LAN with various topology and various protocols To understand WAN, switch, ATM protocol and internetworking devices 							
Unit – I	Pata Communication: The OSI Model – Digital data Transmission – MODEM – ignal Encoding and Decoding – Transmission Modes – Types of Error – Error Detection and Correction (CRC) – Line Configuration – DTE and DCE Interface – Multiplexing.							
Unit – II	Data Link Control Protocol: Flow control and Error Control – Stop and Wait Flow Control – Automatic Repeat Request ARQ – Stop and Wait ARQ – Go Back N ARQ – Selective Reject ARQ – Asynchronous Protocols – X Modem – Y Modem – Z Modem – Synchronous Protocol – Character Oriented Protocol (BSC) – Bit Oriented Protocol (HDLC).							
Unit – III	Local Area Networks (LAN): IEEE 802 Standards – Logical Link Control (LLC) – Media Access Layer Protocol (MAC) – CSMA CD Ethernet – Token Bus Control – Token Ring Control – FDDI – Distributed Queue Dual Bus – Switched Multimegabit Bit Data Service							
Unit – IV	Wide Area Networks (WAN): Circuit Switch – Packet Switch – Message Switching – X 2.5 – Frame Relay – ISDN – ATM Protocol – Internet Working Device – Repeater – Bridge – Routers – Gateways – Routing Algorithm.							
Unit – V	Upper OSI Layers: Session Layer Protocol – Presentation Layer protocol – Data Security – Encryption – Decryption – Authentication – Data Composition – Application Layer Protocol – MHS – File Transfer – Virtual Terminal – CMIP.							
Text and Refe BehrouzA.Ford McGraw	uzan. (2003). Data Communications and Networking	g, – 2 nd Editio	on. T	АТА				
Brijendra Singl	. (2006). Data Communication and Computer Netwo gs. (2004). Data and Computer Communications—	orks– 2nd Ed. 7 th Edition. PI	lition HI.	. PHI	[.			
Outcomes	 Identify components required to design compute Able to use various protocols to design LAN various protocols Identify components and protocols required to and internet 	with various	•					

	Semester – V		
Course Code:		C	H/W
23BEL5I	Internship/Industrial Visit/Field Visit	2	-
Objectives	 To get industrial exposure To learn new techniques from the industrial experts To know the machineries requirement and operation To develop the skill and external resources 		
Outcomes	➤ Able to enrich skill using hands on approach make a become an entrepreneur or good hardware and software d		

	Semester – VI							
Course Code:	Core Course XIII	T/P	C	H/W				
23BEL6C1	ADVANCED COMMUNICATION SYSTEMS	T	4	6				
	> To understand the basic principle, theory and medium	require	d for	optical				
	communication system							
Objectives	➤ To understand cellular communication							
Objectives	To understand Mobile network architecture							
	> To understand satellite communication and its signs	al trans	smissi	on and				
	reception							
	Optical Communication: Basic Optical Communication Sy							
	of Fibers - Ray theory - NA and Multipath Dispersion of							
Unit – I	Attenuation – Optical Sources and Detectors – Point – Point Link System – Link							
	Power Budget - Rise Time Budget - Wave Length Division Multiplexing -							
	Optical Fiber Network – Bus Topology – Ring Topology – Star Topology.							
	Cellular Communication: Concept Of Cellular Mobile Co							
	and Cell Splitting- Frequency Bands Used in Cellular Communication – Absolute							
Unit – II	RF Channel Numbers(ARFCN) – Frequency Reuse- Roaming and Hand off –							
	Authentication of the SIM Card of the Subscribers- IMEI Number, Concept of							
	Data Encryption.							
	ε							
Unit – III	Communication Network- CDMA Technology,-CDMA Overview- Simplified							
	-	Study	of GS	SM and				
	<u> </u>							
				_				
	·	T 4 6 Trequired for optical and required for optical and transmission and system – Classification of SI and GI Fibers – the Link System – Cell munication – Cell munication – Absolute ming and Hand off – Number, Concept of the Concept of cellular Mobile coverview- Simplified study of GSM and sty- Satellite System – Up Link- Down Link-se- Path Loss- Ground arison of TDMA And						
Unit – IV	Block Diagram of Cellular Phone Handset- Comparative Study of GSM and CDMA-2G, 3G and 4G Concepts. Satellite Communication: Introduction- Need- Satellite Orbits- Advantages and Disadvantages of Geostationary Satellites- Satellite Visibility- Satellite System —							
	• • • • • • • • • • • • • • • • • • • •	e- Path	and GI Fibers — k System — Link m Multiplexing — Copology. munication — Cell cation — Absolute and Hand off — mber, Concept of Cellular Mobile view- Simplified day of GSM and - Advantages and Catellite System — Link- Down Link- ath Loss- Ground on of TDMA And					
	Station- Simplified Block Diagram of Earth Station.		2					
Unit – V	Satellite Access: TDMA, FDMA, CDMA Concepts- Compa							
	FDMA- Satellite Antenna (Parabolic Dish Antenna) – GPS-	Services	s Like	SPS &				
D. I. C. D. C	PPSConcept of Bluetooth, Wi-Fi And Wimax.							

Books for Reference:

Andrea Goldsmith.(2015). Wireless communications. Cambridge University.

Lathi, B. P. (2009). *Modern digital and analog Communication systems- 4rd Edition*. Oxford University press.

Martin S. Roden. *Analog & Digital Communication Systems-3rd Edition*. Prentice Hal. Englewood Cliffs.

Theodore S. Rappaport.(2001). Wireless Communications Principles and Practice, 2nd Edition. Pearson Education Asia.

Thiagarajan Vishwanathan. *Telecommunication Switching Systems and Networks*. Prentice Hall of India.

Tomasi, W. *Electronic Communication Systems: Fundamentals through Advanced-3rd Edition.*Pearson Education.

	➤ Identify what are the components required to design optical communication
	system. And how the optical signal carries the information through the various
0.4	types of optical fibers.
Outcomes	➤ Understand the mobile communication, and its network architecture

- > Understand satellite communication and how it does access the information and working of GPS

Semester - VI									
Course Code:	Core Course _ XIV	C	H/W						
23BEL6PR	PROJECT	8	12						
	> To identify the problem								
	> To learn data Collection and literature review								
Objectives	> To design circuits and develop the coding								
	To learn how to prepare a project report								
Outcomes	➤ Able to design a project								
	> Able to write the report								

	Semester - VI								
Course Code:	DSE - III	T/P	C	H/W					
23BEL6E1	COMPUTER HARDWARE AND SYSTEM ASSEMBLING	T	3	5					
	To know the fundamentals of a computer.	ı							
	> To know about mother boards and types of microprocessor used	in the	moth	er board					
	> To know types of memories used in the computer and to know	the a	pplic	ations of					
Objectives	memory to store the type of data and operating systems								
-	> To study about various I/O devices used in the computer, how	they	are i	nterfaced					
	with the computer and its working principle								
	> To understand system assembling procedures in detail to assemble	le a sy	stem.						
	Fundamentals of Computer: Brief introduction with block diagram	n- SM	PS –						
Unit - I	ATX/NLX Power Supply – display adapter – alphanumeric characte	r gene	ratio	n system					
	– MDA,CGA, HGA, EGA, VGA, SVGA, AGP.								
	Organization of motherboard: Form factors - AT, ATX moth	erboar	ds –	different					
II	sections of mother boards – Latest Intel microprocessor – Comparis	son – o	co-pr	ocessor –					
Unit - II	numeric processor – cache memory - chipsets – Bus mastering – ISA, EISA, VESA,								
	PCI,EPCI, PCM CIA- comparison -USB architecture.								
	Memories: RAM, DRAM -RAM - Refreshing - SIMM, DIMM	, DDF	l tecl	nnologies					
IInit III	memory mapping -conventional memory, upper memory, Extended memory, expanded								
Unit - III	memory -Hard disk - construction- low level and high level formatting - HDD								
	interfaces – HDC								
	Input and Output: Keyboard - organization - matrix - keyboard controllers -								
Unit - IV	interfacing of keyboard – key switches – types -keyboard connectors – PS/2 connector,								
Omt - 1V	USB - mouse - working principles — opto electronic mouse, optical mouse , wireless								
	Keyboard, wireless mouse, laser printers –LCD -LED monitors introduction.								
	System assembling procedure: BIOS - CMOS setup - preven								
Unit - V	viruses -data recovery tools - safety precautions - troubleshooting tools - error codes -								
	beep codes - POST sequences - diagnostic software - procedure of installing internet -								
	UPS- latest system specifications Desktop-Laptop-Notebook – Palmtop.								
Books for Refe									
,	2000). Troubleshooting, maintaining & repairing PCs (p. 1448). Osb			aw-Hill.					
	z John Rourke. (2017). PC Hardware: The Complete Reference. Mc	Graw	Hill.						
	A, B. IBM PC clones.								
	. (2006). Modern Computer Hardware Course. BPB Publications.								
Mueller, S. (200	33). <i>Upgrading and repairing PCs</i> . Que Publishing.								
	Identify components used in a computer to form CPU			11 1					
	Knowledge will be acquired the configuration of the processor, n	nemor	ies ar	id hard					
	disk.	,1	1	1					
Outcomes	Knowledge will be acquired about types of processors used in a mother board								
	➤ Knowledge will acquired how the I/O devices are interfaced with	moth	er bo	ard using					
	various ports	1	1	11					
	➤ Skill will be developed to assemble a personal computer using the	e abov	e kno	owiedge.					

	Semester - VI								
Course Code:	DSE - IV	T/P	C	H/W					
23BEL6E2	JAVA PROGRAMMING	T	3	5					
Objectives	 To acquire knowledge on features of Java, structure of and basics of java To acquire knowledge about conditional, looping and I/o syntax To develop the knowledge to handling the array and user To develop the knowledge on exception, inheritar abstraction and encapsulation 	O state	ments	and its					
Unit - I	Introduction to Java Programming: Java Features - Java Java Syntax-, Java keywords- Data Types in Java- Types o	roduction to Java Programming: Java Features - Java Program Structure - a Syntax-, Java keywords- Data Types in Java- Types of Variables in Java, a Local Variables, Java Instance variables, and Java Static Variables or Class riables - Types of Operators in Java.							
Unit - II	Java Control Flow Decision Making, Looping and Branc – else if structure and nested if structure – for loop – while l – enhanced for loop – break, continue and return - Java Operations	ava Control Flow Decision Making, Looping and Branching Statements: if else if structure and nested if structure – for loop – while loop – do while loop enhanced for loop – break, continue and return - Java Input and Output							
Unit - III	Array and User defined methods: Arrays in Java- Create an Array in Java-define Array Size, and Assign values to Array elements. Creating different types of Arrays – Array of Strings - Array of Integers-Array of characters, Operations on Arrays like Find Array Size- copy Arrays- and print Arrays- Java User defined Methods								
Unit - IV	Exception and Inheritance: Java Arithmetic Exception, Java Null Pointer Exception, Java Number Format Exception, and Java Array Index Out of bounds Exception. Inheritance, Types of Inheritance – single level Inheritance, Multilevel Inheritance, and Multiple Inheritance. Java Class members, and								
Unit - V	Reuse Class Members with Inheritance. Polymorphism, Abstraction and Encapsulation: Types of Polymorphism in Java, Compile Time Polymorphism / Method Over Loading and Run-Time Polymorphism / Method Overriding -Abstraction- Create concrete and incomplete methods,-creates Abstract classes and reuse Abstract Classes-Encapsulation - Create getter and setter methods.								
	bks: E.(2019). <i>Programming with Java- VI th Edition</i> . Mc Graw F. (2012). <i>Effective Java- Second Edition</i> . Wesley Professional.		ia.						
	2019). Head First Java- Second Edition. O'Reilly.								
•	a, (2019). Learn Java in 1 Day- 1 st Edition.								
	& Krishna Choppella. (2019). <i>Java Machine Learning, 1st Edi</i>	tion In	gram .	Short					
title.									
Outcomes	 Able to develop simple programs to develop the java pro Able to handle arrays and user defined methods Able to handle exception and inheritance, polymorphi Encapsulation. Skill will be developed on java programming 								

PROFESSIONAL COMPETENCY SKILL- TROUBLESHOOTING AND

MAINTENANCE OF MOBILE CELL PHONES, CCTV and LED/LCD TV

						dits	Hours	CIA	Extonal	er Total
TROUBLESHOOTI NG AND MAINTENANCE OF MOBILE CELL PHONES, CCTV and LED/LCD TV	PROFE SSIONA L COMPE TENCY SKILL	Y	-	-	-	2	2	25	75	100
	Cour	se C	bjec	tive	S	•			•	
Acquire knowledge about	mobile pho	ne,	code	es an	d its	access	ories			
Indentified and working f	unction of I	C s ı	ısed	in m	obil	e phone				
_								ation t	techni	ques
Acquire knowledge on Co	CTV storag	e de	vices	and	l net	working	g techniqu	ies		
Acquire knowledge on LO	CD and LED	TV	ope	ratio	ns a	nd repa	iring tech	nique	S	
	Deta	ils								Course
	_									Objectiv CO1
Basic GSM Code - And Codes -CDMA Phone Co Battery - Housing - Tou Antenna pad - Flex cabl	lroid Mobil odes - Sams ch Pad – Di e – Mic (ar	e pl sung ispla nalog	hone CD y -] g &	Coo MA PCB	des- Cod (Mo	Unive le - Mo therboa	rsal Phor bile Phor rd) - GSI	ne ne M		
Mobile Phone chip components, IC's and their function Resistor – capacitor – Indcutor(coil) – diode – crystal – Transistor – Types of transistor used in mobile phone - Band pass filter – ON/OFF switch – External antenna Socket- Wi-Fi oscillator – coupler – EMI filters-Power IC – PFO/PA IC – Network IC (RF IC) – Wi-Fi IC (W-LAN) – Processor (CPU) – Flash Memory (NAND/eMMC/eMCP) – Touch IC - USB IC (OTG IC) - LED Driver IC(Light IC) - Voltage Regulator IC(DC to DC Converter-LDO) - Audio Ampilifier IC – Protection IC - Mobile Connector, Interface & Test Point - IMEI No of a						- FF III /- ge	12	CO2		
CCTV System, Camera Components of CCTV System Components- Cyconcept of CCTV camera concept of CCTV camera Degree selection- Cable c switchers- connect Switch CCTV storage devices a Types of storage device device-Recording types of	System- IP ber Security and its wor ra parts- Ca connection a ner with CC nd NETWO in CCTV of CCTV c.	-bas /- In k-Pamer nd S TV O ORI - P	ed (ategra arts of ra A locked Came KIN Physical	of Congle of Con	V sy CC CTV, Di CCC Use connorage	TV Syconomic camerostance, D came of swite ection e - DV	stem-Bas a- Workin Width, era-Type cher of storag (R (Digit	ed ic ic sg & of		CO3
	OF MOBILE CELL PHONES, CCTV and LED/LCD TV Acquire knowledge about Indentified and working f Acquire knowledge about Acquire knowledge on Co Acquire knowledge on Co Acquire knowledge on Lo Mobile Phone codes, ma Mobile Phone history - N Basic GSM Code - And Codes -CDMA Phone Co Battery - Housing - Tou Antenna pad - Flex cable ringer) - Camera - vibrate Mobile Phone chip comp Resistor - capacitor - In Types of transistor used switch - External antenn filters-Power IC - PFO/F LAN) - Processor (CPU Touch IC - USB IC (Of Regulator IC(DC to Do Protection IC - Mobile Co mobile phone CCTV System , Camera Components of CCTV System Components- Cy concept of CCTV camera Components connect Switch CCTV storage devices a Types of storage devices device-Recording types of	OF MOBILE CELL PHONES, CCTV and LED/LCD TV SKILL Cour Acquire knowledge about mobile phode indentified and working function of Iversity in the Acquire knowledge about CCTV system acquire knowledge on CCTV storaged acquire knowledge on LCD and LED Deta Mobile Phone codes, major comports in the Acquire knowledge on LCD and LED Deta Mobile Phone codes, major comports in the Acquire knowledge on LCD and LED Deta Mobile Phone codes, major comports in the Acquire knowledge on LCD and LED Deta Mobile Phone codes, major comports in the Acquire knowledge on LCD and LED Deta Mobile Phone codes, major comports in the Acquire knowledge on LCD and LED Deta Mobile Phone codes, major comports in the Acquire knowledge on LCD and LED Deta Mobile Phone codes, major comports in the Acquire knowledge on LCD and LED Deta Mobile Phone codes, major comports in the Mobile Phone codes - Sams Battery - Housing - Touch Pad - De Antenna pad - Flex cable - Mic (arringer) - Camera - vibrator - chargin Mobile Phone chip components, IC Resistor - capacitor - Indcutor(coil Types of transistor used in mobile phone pswitch - External antenna Socket- filters-Power IC - PFO/PA IC - Ne LAN) - Processor (CPU) - Flash I Touch IC - USB IC (OTG IC) - LI Regulator IC(DC to DC Convertered Protection IC - Mobile Connector, Interpolated in the Acquire and its work concept of CCTV system, Camera, Switcher and its work concept of CCTV camera parts- Camera parts- Camera selection- Cable connection as switchers- connect Switcher with CCC CCTV storage devices and NETW Types of storage device in CCTV device-Recording types of CCTV camera in CCTV in CCTV device-Recording types of CCTV camera in CCTV in CCT	OF MOBILE CELL PHONES, CCTV and LED/LCD TV SKILL Course Course Course Course Require knowledge about mobile phone, and Led representations of IC structure in the course of CCTV system, and Led representations of IC structure in the course of CCTV system, and the course of CCTV system, and the course of CCTV storage de and the course of CCTV storage device and the course of CCTV camera and its work-processor of CCTV storage device and the course of CCTV camera parts- Camera device-Recording types of CCTV camera device-course of CCTV camera device-course of CCTV camera device-course of CCTV camera device-course of CCTV camera device in CCTV camera device-Recording types of CCTV camera device-course of C	OF MOBILE CELL PHONES, CCTV and LED/LCD TV SKILL Course Object Acquire knowledge about mobile phone, code Indentified and working function of IC s used Acquire knowledge about CCTV system, cam Acquire knowledge on CCTV storage devices Acquire knowledge on LCD and LED TV ope Details Mobile Phone codes, major components and Mobile Phone history - Mobile phone overvion Basic GSM Code - Android Mobile phone Codes - CDMA Phone Codes - Samsung CD Battery - Housing - Touch Pad - Display - I Antenna pad - Flex cable - Mic (analog & ringer) - Camera - vibrator - charging pad Mobile Phone chip components, IC's and the Resistor - capacitor - Indeutor(coil) - dioded Types of transistor used in mobile phone - Beswitch - External antenna Socket- Wi-Fi os filters-Power IC - PFO/PA IC - Network IC LAN) - Processor (CPU) - Flash Memory Touch IC - USB IC (OTG IC) - LED Drive Regulator IC(DC to DC Converter-LDO) Protection IC - Mobile Connector, Interface & mobile phone CCTV System, Camera, Switcher and Instance of CCTV System Components of CCTV System IP-based Components of CCTV camera and its work- Parts of concept of CCTV camera and its work- Parts of concept of CCTV camera parts- Camera A Degree selection- Cable connection and Sockes switchers- connect Switcher with CCTV Camera CCTV storage devices and NETWORKING Types of storage device in CCTV - Physical device-Recording types of CCTV camera for CCTV camera for CCTV storage devices in CCTV - Physical concept of CCTV storage devices and NETWORKING Types of storage device in CCTV - Physical concept of CCTV camera for C	OF MOBILE CELL PHONES, CCTV and LED/LCD TV SKILL Course Objective Acquire knowledge about mobile phone, codes an Indentified and working function of IC s used in macquire knowledge about CCTV system, camera, Acquire knowledge on CCTV storage devices and Acquire knowledge on LCD and LED TV operation Details Mobile Phone codes, major components and the Mobile Phone history - Mobile phone overview - Basic GSM Code - Android Mobile phone Codes - CDMA Phone Codes - Samsung CDMA Battery - Housing - Touch Pad - Display - PCB Antenna pad - Flex cable - Mic (analog & diginal ringer) - Camera - vibrator - charging pad Mobile Phone chip components, IC's and their is Resistor - capacitor - Indcutor(coil) - diode - Types of transistor used in mobile phone - Band switch - External antenna Socket- Wi-Fi oscilla filters-Power IC - PFO/PA IC - Network IC (RI LAN) - Processor (CPU) - Flash Memory (NA Touch IC - USB IC (OTG IC) - LED Driver IC Regulator IC(DC to DC Converter-LDO) - At Protection IC - Mobile Connector ,Interface & Tes mobile phone CCTV System , Camera, Switcher and Installat Components of CCTV System- IP-based CCT System Components- Cyber Security- Integrating concept of CCTV camera and its work- Parts of Coconcept of CCTV camera parts- Camera Angle Degree selection- Cable connection and Socket of switchers- connect Switcher with CCTV Camera- CCTV storage devices and NETWORKING Types of storage device in CCTV - Physical device-Recording types of CCTV camera for storage device and NETWORKING	OF MOBILE CELL PHONES, CCTV and LED/LCD TV SKILL Course Objectives Acquire knowledge about mobile phone, codes and its Indentified and working function of IC s used in mobil Acquire knowledge about CCTV system, camera, swith Acquire knowledge on CCTV storage devices and net Acquire knowledge on LCD and LED TV operations a Details Mobile Phone codes, major components and their fit Mobile Phone history - Mobile phone overview - Mobile Phone history - Mobile phone codes-Codes -CDMA Phone Codes - Samsung CDMA Code Battery - Housing - Touch Pad - Display - PCB(Mo Antenna pad - Flex cable - Mic (analog & digital) - ringer) - Camera - vibrator - charging pad Mobile Phone chip components, IC's and their funce Resistor - capacitor - Indcutor(coil) - diode - cryst Types of transistor used in mobile phone - Band pass switch - External antenna Socket- Wi-Fi oscillator filters-Power IC - PFO/PA IC - Network IC (RF IC LAN) - Processor (CPU) - Flash Memory (NAND Touch IC - USB IC (OTG IC) - LED Driver IC(Lig Regulator IC(DC to DC Converter-LDO) - Audio Protection IC - Mobile Connector, Interface & Test Pomobile phone CCTV System , Camera, Switcher and Installation Components of CCTV System- IP-based CCTV system Components - Cyber Security- Integrating CC concept of CCTV camera and its work- Parts of CCTV concept of CCTV camera parts- Camera Angle, Di Degree selection- Cable connection and Socket of CC switchers- connect Switcher with CCTV Camera- Use CCTV storage devices and NETWORKING Types of storage device in CCTV - Physical connedevice-Recording types of CCTV camera for storage	OF MOBILE CELL PHONES, CCTV and LED/LCD TV SKILL Course Objectives Acquire knowledge about mobile phone, codes and its access. Indentified and working function of IC s used in mobile phone Acquire knowledge about CCTV system, camera, switchers a Acquire knowledge on CCTV storage devices and networking Acquire knowledge on LCD and LED TV operations and repa Details Mobile Phone codes, major components and their function Mobile Phone history - Mobile phone overview - Mobile phoses acquire codes - Android Mobile phone Codes - Unive Codes - CDMA Phone Codes - Samsung CDMA Code - Mo Battery - Housing - Touch Pad - Display - PCB(Motherboa Antenna pad - Flex cable - Mic (analog & digital) - speak ringer) - Camera - vibrator - charging pad Mobile Phone chip components, IC's and their function Resistor - capacitor - Indcutor(coil) - diode - crystal - T Types of transistor used in mobile phone - Band pass filter switch - External antenna Socket- Wi-Fi oscillator - coup ifleters-Power IC - PFO/PA IC - Network IC (RF IC) - Wi-LAN) - Processor (CPU) - Flash Memory (NAND/eMMC Touch IC - USB IC (OTG IC) - LED Driver IC(Light IC) Regulator IC(DC to DC Converter-LDO) - Audio Ampi Protection IC - Mobile Connector, Interface & Test Point - IM mobile phone CCTV System , Camera, Switcher and Installation Components of CCTV System- IP-based CCTV systems-System Components- Cyber Security- Integrating CCTV Syconcept of CCTV camera and its work- Parts of CCTV camera concept of CCTV camera and its work- Parts of CCTV camera switchers- connect Switcher with CCTV Camera- Use of switchers- connect Switcher with CCTV Camera- Use of switchers- connect Switcher with CCTV Camera- Use of switchers- connect Switcher with CCTV - Physical connection device-Recording types of CCTV camera for storage - DV	OF MOBILE CELL PHONES, CCTV and LED/LCD TV SKILL Course Objectives Acquire knowledge about mobile phone , codes and its accessories Indentified and working function of IC s used in mobile phone Acquire knowledge about CCTV system, camera, switchers and install Acquire knowledge on CCTV storage devices and networking technique Acquire knowledge on LCD and LED TV operations and repairing technique Acquire knowledge on LCD and LED TV operations and repairing technique Acquire knowledge on LCD and LED TV operations and repairing technique Acquire knowledge on LCD and LED TV operations and repairing technique Acquire knowledge on LCD and LED TV operations and repairing technique Acquire knowledge on LCD and LED TV operations and repairing technique Acquire knowledge on LCD and LED TV operations and repairing technique Acquire knowledge on LCD and LED TV operations and repairing technique Acquire knowledge on LCD and LED TV operations and repairing technique knowledge on LCD and LED TV operations and repairing technique knowledge on LCD and LED TV operations and repairing technique knowledge on LCD and LED TV operations and repairing technique knowledge on LCD and LED TV operations and repairing technique knowledge on LCD and LED TV operations and repairing technique knowledge on LCD and LED TV operations and repairing technique knowledge on LCD and LCD Additional Phone Codes - Android Mobile phone Codes - Universal Phone Codes - Universal Phone Codes - Universal Phone Codes - Universal Phone Codes - CDMA Phone Codes - Android Mobile phone Codes - Universal Phone Codes - Universal Phone Codes - Universal Phone Codes - Universal Phone Codes - CDMA Phone Codes - Android Mobile phone Codes - Universal Phone Cod	OF MOBILE CELL PHONES, CCTV and LED/LCD TV SKILL Course Objectives Acquire knowledge about mobile phone , codes and its accessories Indentified and working function of IC s used in mobile phone Acquire knowledge about CCTV system, camera, switchers and installation of Acquire knowledge on CCTV storage devices and networking techniques Acquire knowledge on LCD and LED TV operations and repairing techniques Details Mobile Phone codes, major components and their function Mobile Phone history - Mobile phone overview - Mobile phone Codes-Basic GSM Code - Android Mobile phone Codes- Universal Phone Codes - CDMA Phone Codes - Samsung CDMA Code - Mobile Phone Battery - Housing - Touch Pad - Display - PCB(Motherboard) - GSM Antenna pad - Flex cable - Mic (analog & digital) - speaker (ear & ringer) - Camera - vibrator - charging pad Mobile Phone chip components, IC's and their function Resistor - capacitor - Indcutor(coil) - diode - crystal - Transistor - Types of transistor used in mobile phone - Band pass filter - ON/OFF switch - External antenna Socket- Wi-Fi oscillator - coupler - EMI filters-Power IC - PFO/PA IC - Network IC (RF IC) - Wi-Fi IC (W-LAN) - Processor (CPU) - Flash Memory (NAND/eMMC/eMCP) - Touch IC - USB IC (OTG IC) - LED Driver IC(Light IC) - Voltage Regulator IC(DC to DC Converter-LDO) - Audio Ampilifier IC - Protection IC - Mobile Connector ,Interface & Test Point - IMEI No of a mobile phone CCTV System , Camera, Switcher and Installation Components of CCTV System- IP-based CCTV system-Basic concept of CCTV camera and its work- Parts of CCTV camera - Working concept of CCTV camera and its work- Parts of CCTV camera- Working concept of CCTV camera and its work- Parts of CCTD camera-Type of switchers- connect Switcher with CCTV Camera- Use of switcher	OF MOBILE CELL PHONES, CCTV and LED/LCD TV SKILL Course Objectives Acquire knowledge about mobile phone , codes and its accessories Indentified and working function of IC s used in mobile phone Acquire knowledge about CCTV system, camera, switchers and installation technical Acquire knowledge on CCTV storage devices and networking techniques Acquire knowledge on LCD and LED TV operations and repairing techniques Details No. of Hours Mobile Phone codes, major components and their function Mobile Phone history - Mobile phone codes- Universal Phone Codes- COBMA Phone Codes - Samsung CDMA Code - Mobile Phone Battery - Housing - Touch Pad - Display - PCB(Motherboard) - GSM Antenna pad - Flex cable - Mic (analog & digital) - speaker (ear & ringer) - Camera - vibrator - charging pad Mobile Phone chip components, IC's and their function Resistor - capacitor - Indcutor(coil) - diode - crystal - Transistor - Types of transistor used in mobile phone - Band pass filter - ON/OFF switch - External antenna Socket- Wi-Fi oscillator - coupler - EMI filters-Power IC - PFO/PA IC - Network IC (RF IC) - Wi-Fi IC (W-LAN) - Processor (CPU) - Flash Memory (NAND/eMMC/eMCP) - Touch IC - USB IC (OTG IC) - LED Driver IC(Light IC) - Voltage Regulator IC(DC to DC Converter-LDO) - Audio Ampilifier IC - Protection IC - Mobile Connector, Interface & Test Point - IMEI No of a mobile phone CCTV System, Camera, Switcher and Installation Components of CCTV system- IP-based CCTV systems- Basic concept of CCTV camera and its work- Parts of CCTV camera-Working concept of CCTV camera parts- Camera Angle, Distance, Width, & Degree selection- Cable connection and Socket of CCD camera-Type of switchers connect Switcher with CCTV Camera - Use of switcher CCTV storage devices and NETWORKING Types of storage device in CCTV camera for storage - DVR (Digital

		tion - LAN & WAN Network Setup Configuration - Routers and - Control Panel of Routers - Practice on Android based					
TT •4 T7		tion for DVR and NVR to view camera online	10	GO.			
Unit V		LCD TV REPAIRING	12	CO5			
		action of LED/LCD /CRT TV - Block diagram of Led/Lcd TV					
		art TV -Identify of LED/LCD TV function - Difference between					
		d and lcd tv – LED/LCD TV power circuit board details- Power					
		circuit testing & repairing solutions - Main board testing of TV -					
	LCD/L	ED TV all voltage tracing - LED/LCD TV screen testing and					
		Led repairing tools details- Bios update & flash with bios					
	prograi	mmer- Led TV remote function details.					
	Total		60				
	•	Course Outcomes					
Cou	ırse	On completion of this course, students will;					
Outc	omes						
CC	D1	Identify different types of mobile cell phones					
		Identify the parts and its functions of a mobile cell phone,					
CO	D2	Identify and Understand the function of ICs used in cell phone					
		Use the correct hardware tools to repair mobile cell phones,					
		Assembly and disassembly a mobile cell phone					
		Identify mobile cell phone faults and solve them.					
CO)3	Understand CCTV system and its components					
CO		Skill on Installation Switchers and Networking					
CO		Skill on maintenance of LCD/LED TV					
		Text Books					
1 1	Mohile Pl	none Code Book, Universal Institute, New road Kathmandu					
		none Hardware Book, Universal Institute, New road Kathmandu					
		none Repairing, Universal Institute, New road Kathmandu	1 4 !	A T I ?			
		Iill, CCTV Handbook: Buying, Installing, Configuring, & Troubles	nooting A	A User's			
		CCTV Security, Kindle Edition, 2019	Z: 11 - E -	1:4: 202			
		y Kimathi and Ron Bertrand, LCD-LED Television Repair Guide, I	Cinale Ed	11t1on, 202			
6 I	LCD/LEL	O TV Repair Book, Universal Institute, New road Kathmandu					
1 01	1 11 0	References Books	ъ.	1			
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		als (Smartphones and Tablets Repairs), Kindle Edition, 2021.	C1 '11 TZ	. 11			
		arandu, Smartphones and Tablets Repairs: Money Making Venture	e Skill, K	inale			
	dition, 20		11 - 12 12 12	i 2022			
		i, CCTV Surveillance: A CCTV security system training book, Kin					
		ri, CCTV cameras training: A training book for analogue CCTV car	neras Kıı	ndle			
	dition, 20						
		af Khan, Practical LCD/LED TV Training Course A Book for Begi	ners and				
		s, Saz Publication, First Edition 2021					
6 H	umphrey	Kimathi, LCD-LED TELEVISION REPAIR GUIDE Kindle Edition	on, 2021				
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_		etraininginkathmandunepal.com/mobile-phone-repair-pdf-book-fre	e-downlo	oad/			
		Trouble shooting and repairing LCD TVs, <u>www.preher</u> -tech.com					
3 http	s://mobil	etraininginkathmandunepal.com/lcd-led-tv-repair-book/					